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FJP2145

ESBC™ Rated NPN Power Transistor

ESBC Features (FDC655 MOSFET)

$V_{CS(ON)}$	I_C	Equiv. $R_{CS(ON)}^{(1)}$
0.21 V	2 A	0.105 Ω

- Low Equivalent On Resistance
- Very Fast Switch: 150 kHz
- Wide RBSOA: Up to 1100 V
- Avalanche Rated
- Low Driving Capacitance, No Miller Capacitance
- Low Switching Losses
- Reliable HV Switch: No False Triggering due to High dv/dt Transients

Applications

- High-Voltage, High-Speed Power Switch
- Emitter-Switched Bipolar/MOSFET Cascode (ESBC™)
- Smart Meters, Smart Breakers, SMPS, HV Industrial Power Supplies
- Motor Drivers and Ignition Drivers



Figure 1. Pin Configuration

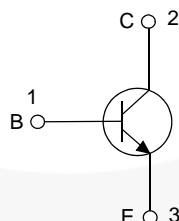


Figure 2. Internal Schematic Diagram

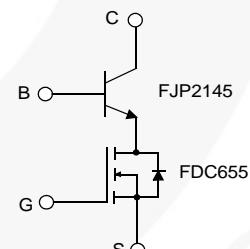


Figure 3. ESBC Configuration⁽²⁾

Ordering Information

Part Number	Marking	Package	Packing Method
FJP2145TU	J2145	TO-220	TUBE

Notes:

1. Figure of Merit.
2. Other Fairchild MOSFETs can be used in this ESBC application.

Absolute Maximum Ratings⁽³⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	1100	V
V_{CEO}	Collector-Emitter Voltage	800	V
V_{EBO}	Emitter-Base Voltage	7	V
I_C	Collector Current	5	A
I_B	Base Current	1.5	A
P_C	Collector Dissipation ($T_C = 25^\circ\text{C}$)	120	W
T_J	Operating and Junction Temperature Range	-55 to +125	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
EAR ⁽⁴⁾	Avalanche Energy ($T_J = 25^\circ\text{C}$, 1.2 mH)	15	mJ

Notes:

3. Pulse test is pulse width ≤ 5 ms, duty cycle $\leq 10\%$.
4. Lab characterization data only for reference.

Thermal Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Max.	Unit
$R_{\theta jC}$	Thermal Resistance, Junction to Case	1.04	$^\circ\text{C}/\text{W}$
$R_{\theta jA}$	Thermal Resistance, Junction to Ambient	78.72	$^\circ\text{C}/\text{W}$

Electrical Characteristics⁽⁵⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = 1 \text{ mA}, I_E = 0$	1100			V
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 5 \text{ mA}, I_B = 0$	800			V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = 1 \text{ mA}, I_C = 0$	7			V
I_{CBO}	Collector Cut-off Current	$V_{CB} = 800 \text{ V}, I_E = 0$			10	μA
I_{EBO}	Emitter Cut-off Current	$V_{EB} = 5 \text{ V}, I_C = 0$			10	μA
h_{FE1}	DC Current Gain	$V_{CE} = 5 \text{ V}, I_C = 0.2 \text{ A}$	20		40	
h_{FE2}		$V_{CE} = 5 \text{ V}, I_C = 1 \text{ A}$	8			
$V_{CE(\text{sat})}$	Collector-Emitter Saturation Voltage	$I_C = 0.25 \text{ A}, I_B = 0.05 \text{ A}$		0.049		V
		$I_C = 0.5 \text{ A}, I_B = 0.167 \text{ A}$		0.052		V
		$I_C = 1 \text{ A}, I_B = 0.33 \text{ A}$		0.082		V
		$I_C = 1.5 \text{ A}, I_B = 0.3 \text{ A}$		0.151	2.000	V
$V_{BE(\text{sat})}$	Base-Emitter Saturation Voltage	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.752		V
		$I_C = 1.5 \text{ A}, I_B = 0.3 \text{ A}$		0.833	1.500	V
		$I_C = 2 \text{ A}, I_B = 0.4 \text{ A}$		0.855		V
C_{IB}	Input Capacitance	$V_{EB} = 5 \text{ V}, I_C = 0, f = 1 \text{ MHz}$		1.618		pF
C_{OB}	Output Capacitance	$V_{CB} = 200 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		11.39		pF
f_T	Current Gain Bandwidth Product	$V_{CE} = 10 \text{ V}, I_C = 0.2 \text{ A}$		15		MHz

Note:

5. Pulse test is pulse width $\leq 5 \text{ ms}$, duty cycle $\leq 10\%$.

ESBC-Configured Electrical Characteristics⁽⁶⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
f_T	Current Gain Bandwidth Product	$I_C = 0.1 \text{ A}, V_{CE} = 10 \text{ V}$		28.40		MHz
l_{tf}	Inductive Current Fall Time			95		ns
t_s	Inductive Storage Time			0.13		ns
V_{tf}	Inductive Voltage Fall Time			135		ns
V_{tr}	Inductive Voltage Rise Time			80		ns
t_c	Inductive Crossover Time			115		ns
l_{tf}	Inductive Current Fall Time			50		ns
t_s	Inductive Storage Time			0.34		ns
V_{tf}	Inductive Voltage Fall Time			150		ns
V_{tr}	Inductive Voltage Rise Time			60		ns
t_c	Inductive Crossover Time			95		ns
V_{CSW}	Maximum Collector-Source Voltage at Turn-off without Snubber	$h_{FE} = 5, I_C = 2 \text{ A}$	1100			V
$I_{GS(OS)}$	Gate-Source Leakage Current	$V_{GS} = \pm 20 \text{ V}$		1		nA
$V_{CS(ON)}$	Collector-Source On Voltage	$V_{GS} = 10 \text{ V}, I_C = 2 \text{ A}, I_B = 0.67 \text{ A}, h_{FE} = 3$		0.202		V
		$V_{GS} = 10 \text{ V}, I_C = 1 \text{ A}, I_B = 0.33 \text{ A}, h_{FE} = 3$		0.111		V
		$V_{GS} = 10 \text{ V}, I_C = 0.5 \text{ A}, I_B = 0.17 \text{ A}, h_{FE} = 3$		0.067		V
		$V_{GS} = 10 \text{ V}, I_C = 0.3 \text{ A}, I_B = 0.06 \text{ A}, h_{FE} = 5$		0.060		V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{BS} = V_{GS}, I_B = 250 \mu\text{A}$		1.9		V
C_{iss}	Input Capacitance ($V_{GS} = V_{CB} = 0$)	$V_{CS} = 25 \text{ V}, f = 1 \text{ MHz}$		470		pF
$Q_{GS(tot)}$	Gate-Source Change $V_{CB} = 0$	$V_{GS} = 10 \text{ V}, I_C = 6.3 \text{ A}, V_{CS} = 25 \text{ V}$		9		nC
$R_{DS(ON)}$	Static Drain-to-Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		21		mΩ
		$V_{GS} = 4.5 \text{ V}, I_D = 5.5 \text{ A}$		26		mΩ
		$V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}, T_J = 125^\circ\text{C}$		30		mΩ

Note:

6. A typical FDC655 MOSFET was used for the specifications above. Values could vary if other Fairchild MOSFETs are used.

Typical Performance Characteristics

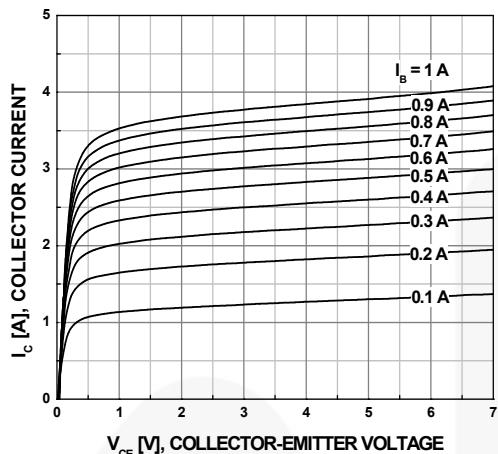


Figure 4. Static Characteristics

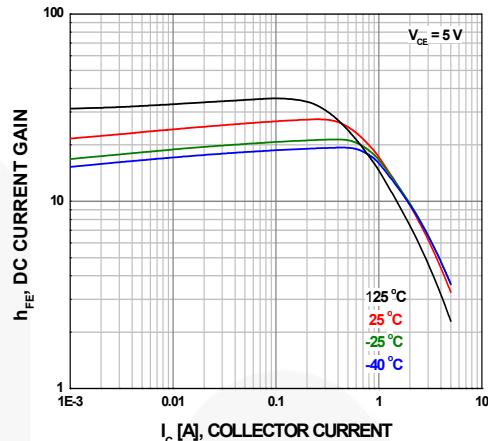


Figure 5. DC Current Gain

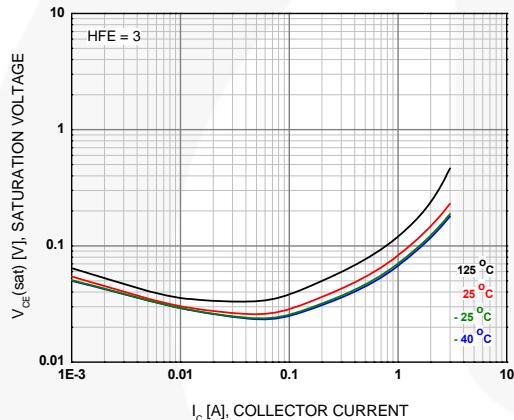


Figure 6. Collector-Emitter Saturation Voltage
 $h_{FE} = 3$

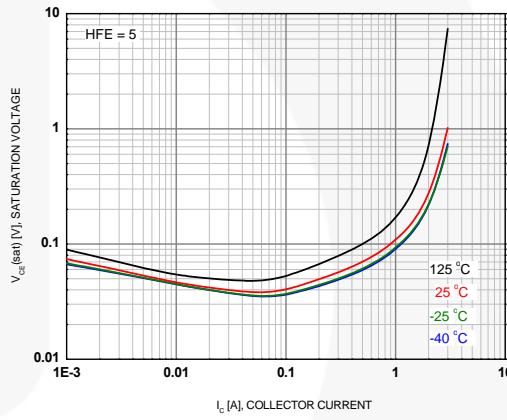


Figure 7. Collector-Emitter Saturation Voltage
 $h_{FE} = 5$

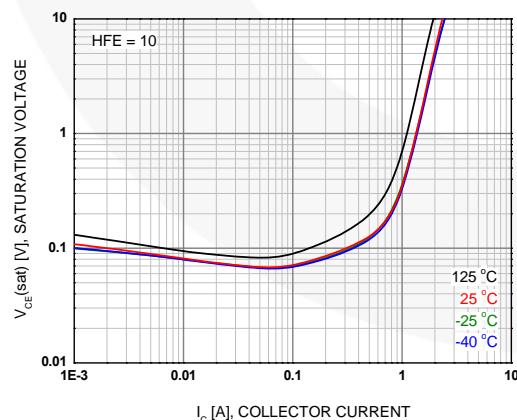


Figure 8. Collector-Emitter Saturation Voltage
 $h_{FE} = 10$

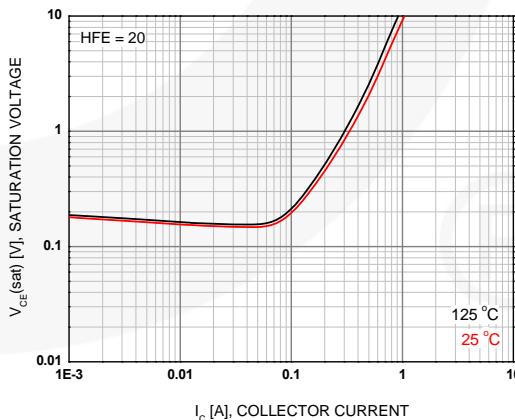


Figure 9. Collector-Emitter Saturation Voltage
 $h_{FE} = 20$

Typical Performance Characteristics (Continued)

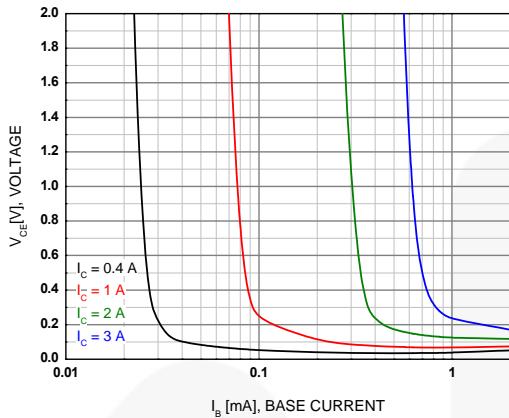


Figure 10. Typical Collector Saturation Voltage

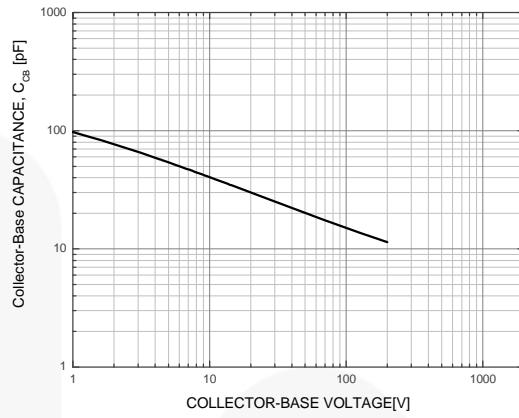


Figure 11. Capacitance

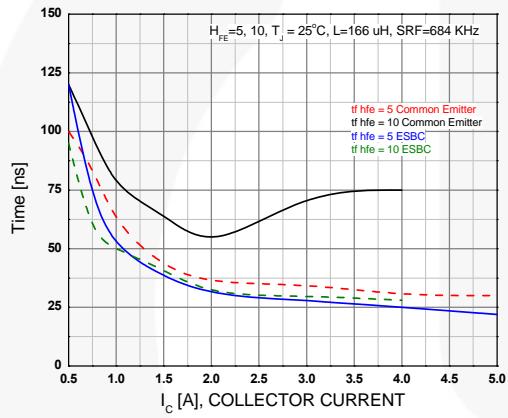


Figure 12. Inductive Load Collector Current Fall - Time (t_f)

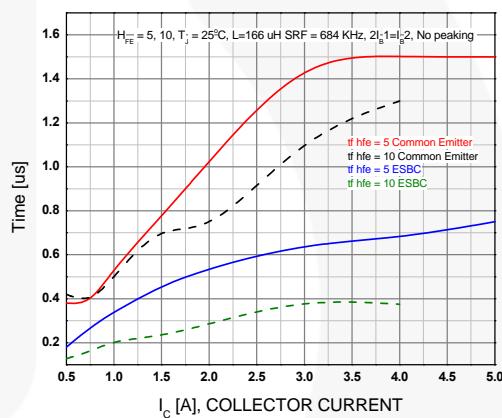


Figure 13. Inductive Load Collector Current Storage - Time (t_{stg})

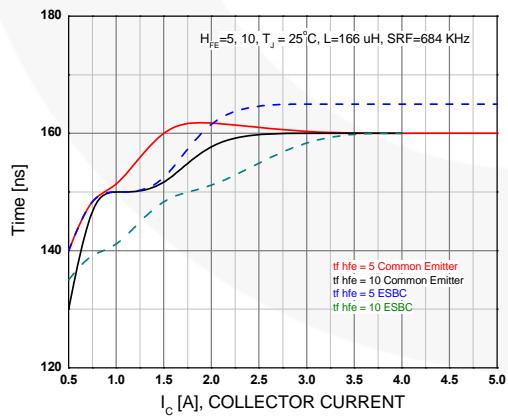


Figure 14. Inductive Load Collector Voltage Fall - Time (t_f)

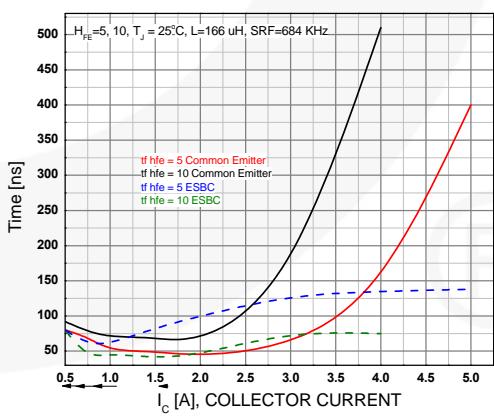


Figure 15. Inductive Load Collector Voltage Rise - Time (t_r)

Typical Performance Characteristics (Continued)

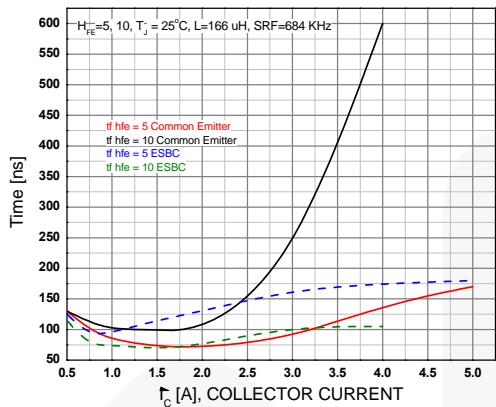


Figure 16. Inductive Load Collector Current / Voltage Crossover (t_c)

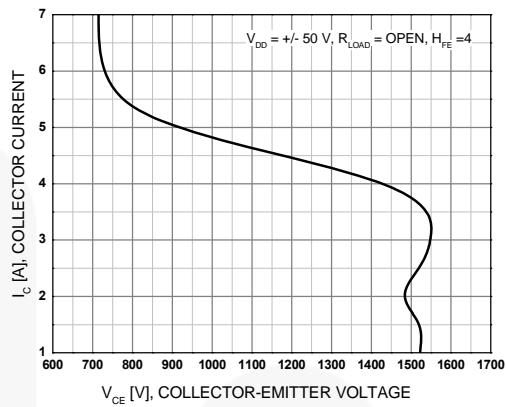


Figure 17. BJT RBSOA

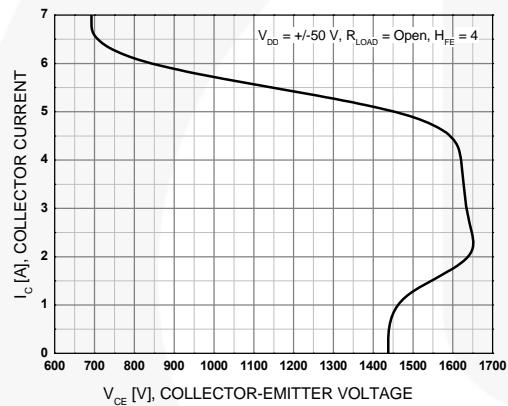


Figure 18. ESBC RBSOA

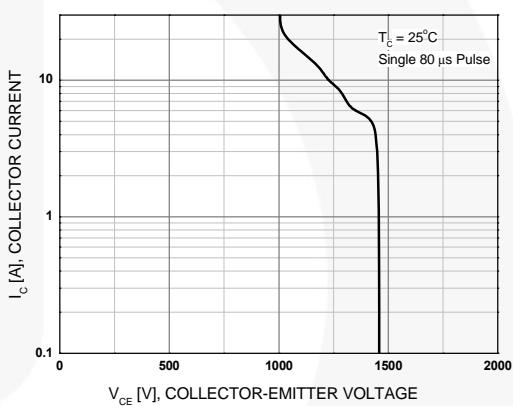


Figure 19. Crossover FBSOA

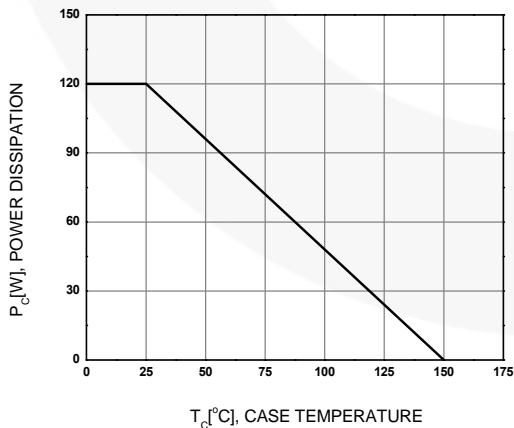


Figure 20. Power Derating

Test Circuits

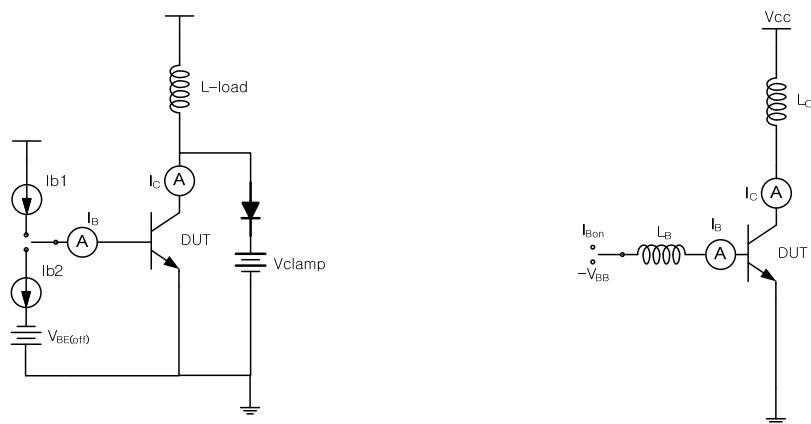


Figure 21. Test Circuit For Inductive Load and Reverse Bias Safe Operating

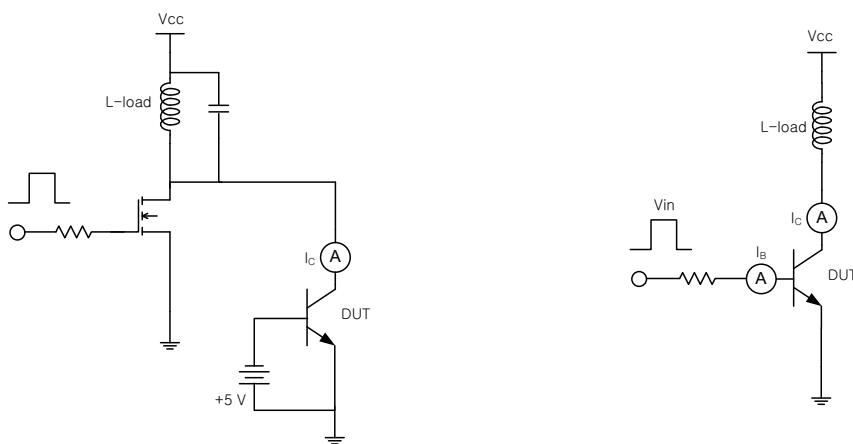


Figure 22. Energy Rating Test Circuit

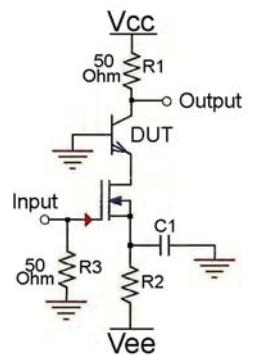


Figure 23. Ft Measurement

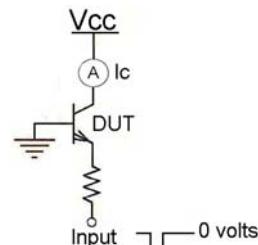


Figure 24. FBSOA

Test Circuits (Continued)

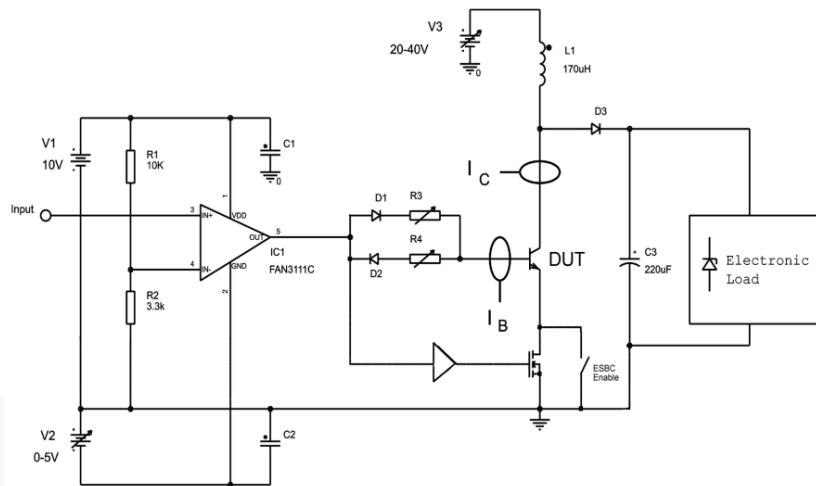


Figure 25. Simplified Saturated Switch Driver Circuit

Functional Test Waveforms

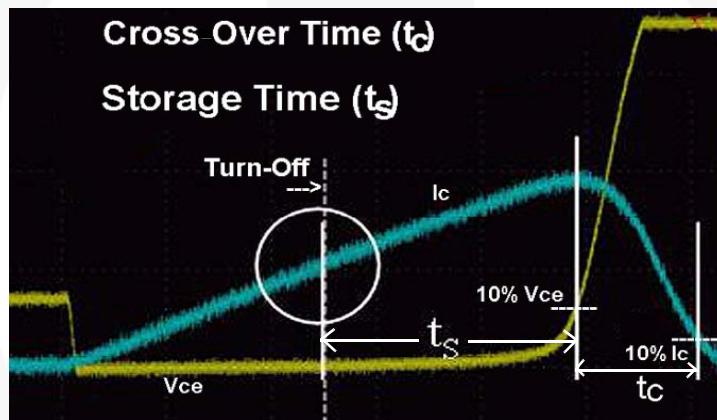


Figure 26. Crossover Time Measurement

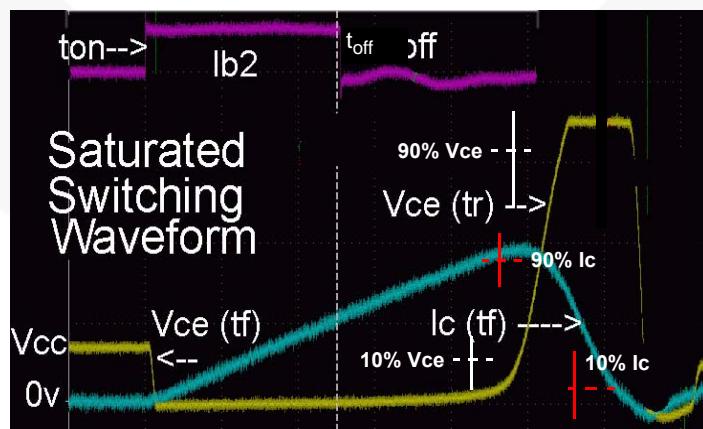


Figure 27. Saturated Switching Waveform

Functional Test Waveforms (Continued)

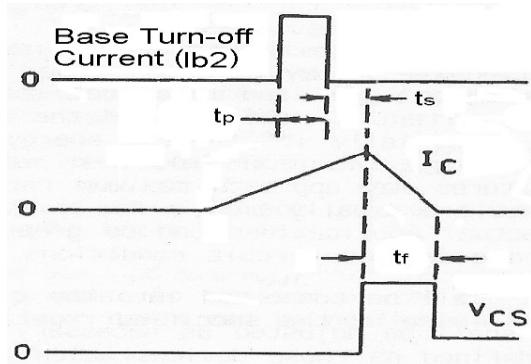


Figure 28. Storage Time - Common Emitter Base Turn Off (I_{b2}) to I_C Fall - Time

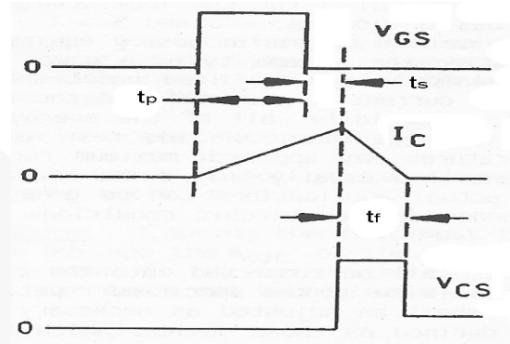
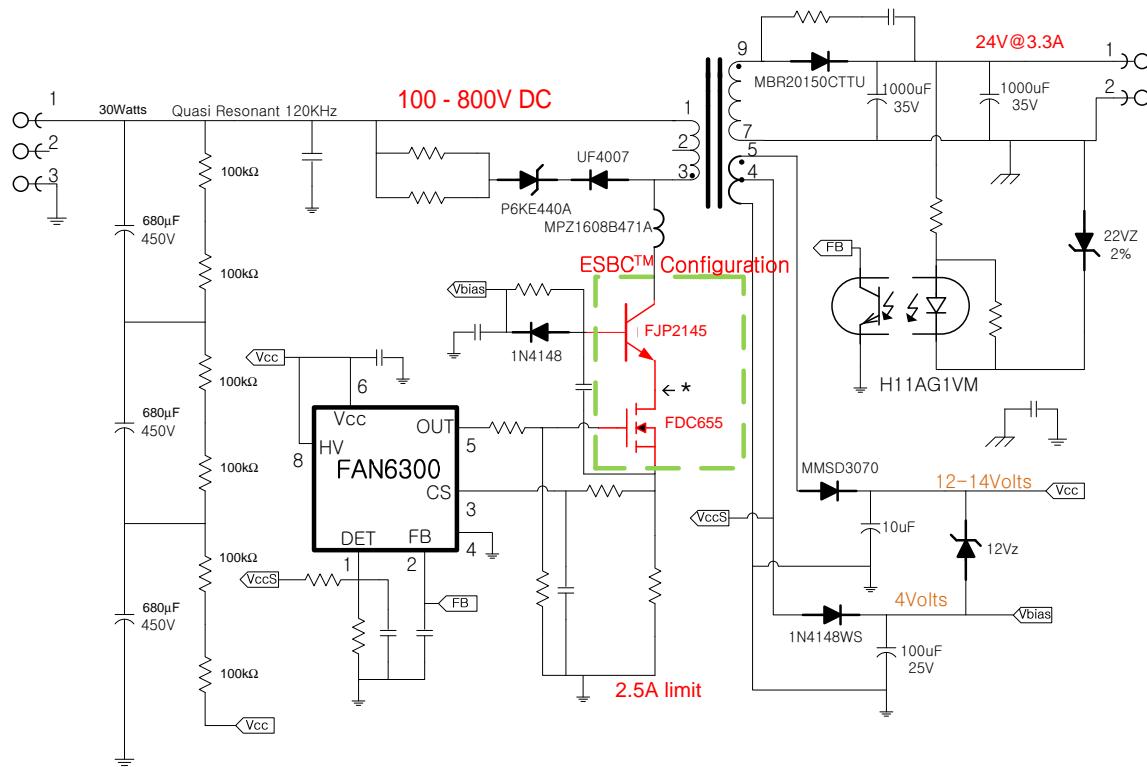


Figure 29. Storage Time - ESBC FET Gate (Off) to I_C Fall - Time

Very Wide Input Voltage Range Supply



* Make short as possible

Figure 30. 30 W; Secondary-Side Regulation: 3 Capacitor Input; Quasi Resonant

Driving ESBC Switches

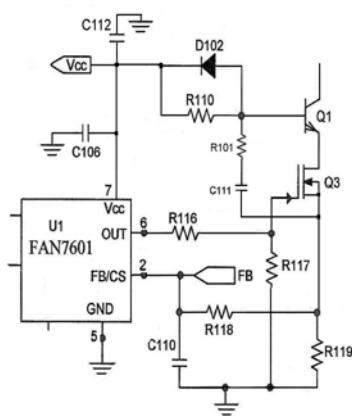


Figure 31. V_{CC} Derived

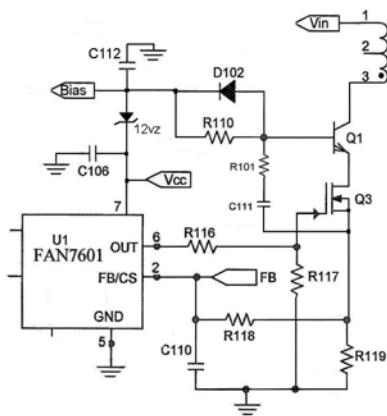


Figure 32. V_{BIAS} Supply Derived

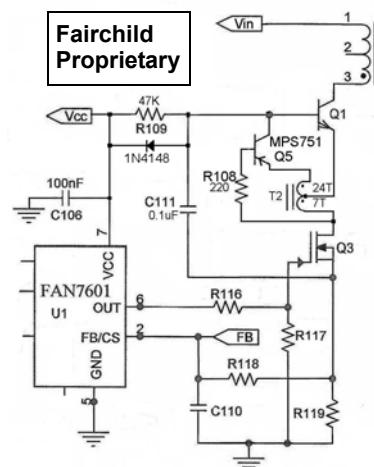


Figure 33. Proportional Drive

Physical Dimensions

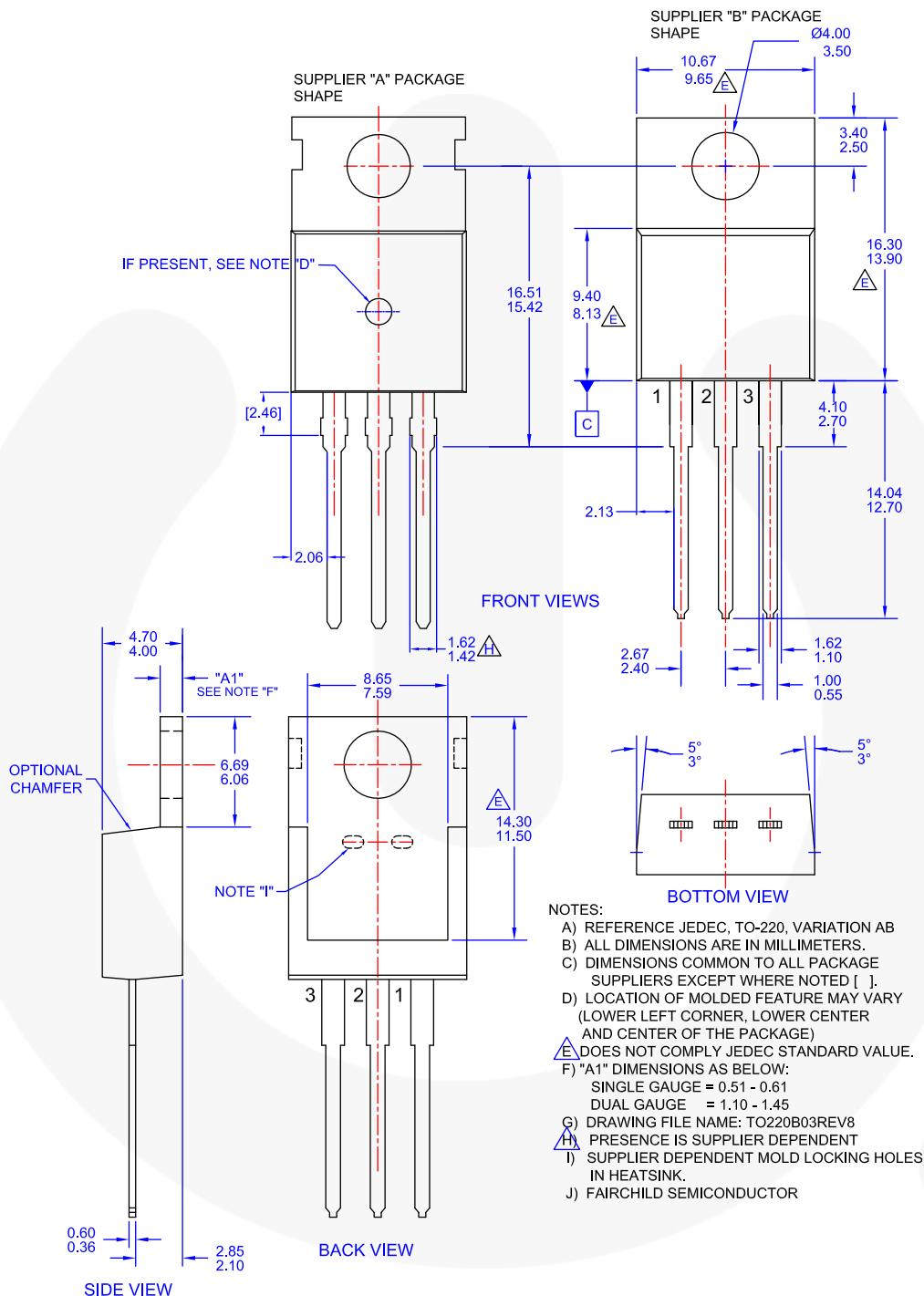


Figure 34. TO-220, MOLDED, 3-LEAD, JEDEC VARIATION AB



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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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